## **ITEQ** Corporation

**2023 Fourth Quarter Investor Presentation** 

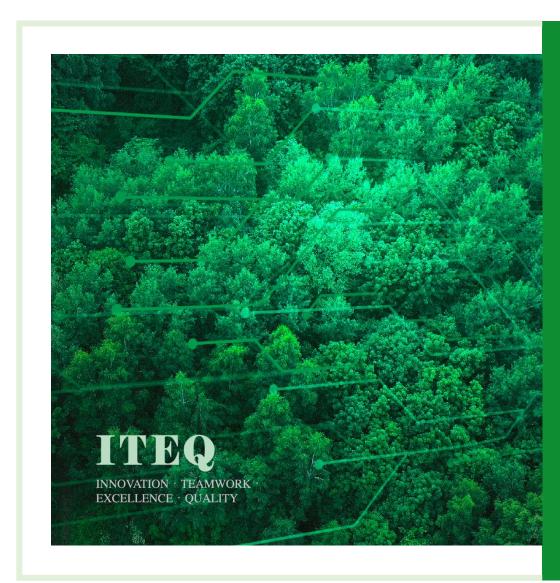


INNOVATION. TEAMWORK. EXCELLENCE. QUALITY

March 2024

#### **Disclaimer Statement**

- This presentation and release contain "forward-looking statements" which may include projections of future results of operations, financial condition or business prospects based on our own information and other sources.
- Our actual results of operations, financial condition or business prospects may differ from those expressed or implied in these forward-looking statements for a variety of reasons, including but not limited to market demand, price fluctuations, competition, international economic conditions, supply chain issues, exchange rate fluctuations and other risks and factors beyond our control.
- The forward-looking statements in this release reflect the current belief of ITEQ as of the date of this release. ITEQ undertakes no obligation to update these forward-looking statements for events or circumstances that occur subsequent to such date.





## **Company Overview**

Establishment April 10<sup>th</sup>, 1997

Headquarters HsinChu, Taiwan



Employees ~4,000



Audrey Tsai

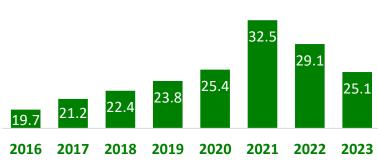


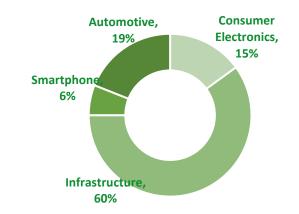
#### Main Products

**Revenue (NT\$ billion)** 

Copper Clad Laminate (CCL) & Prepreg (PP) | Masslam service | Flexible CCL

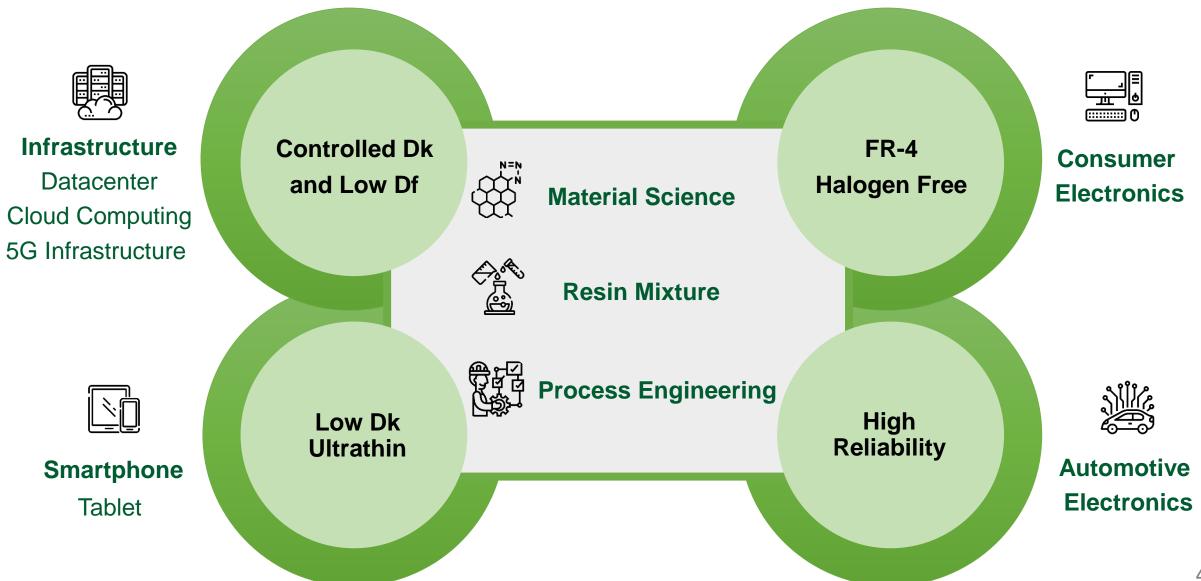
#### Revenue by Application (FY23)

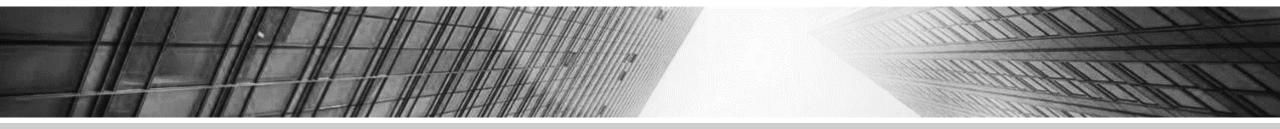




### **Key Technology Applications**







## **Growth Strategy Blueprint**

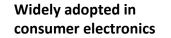


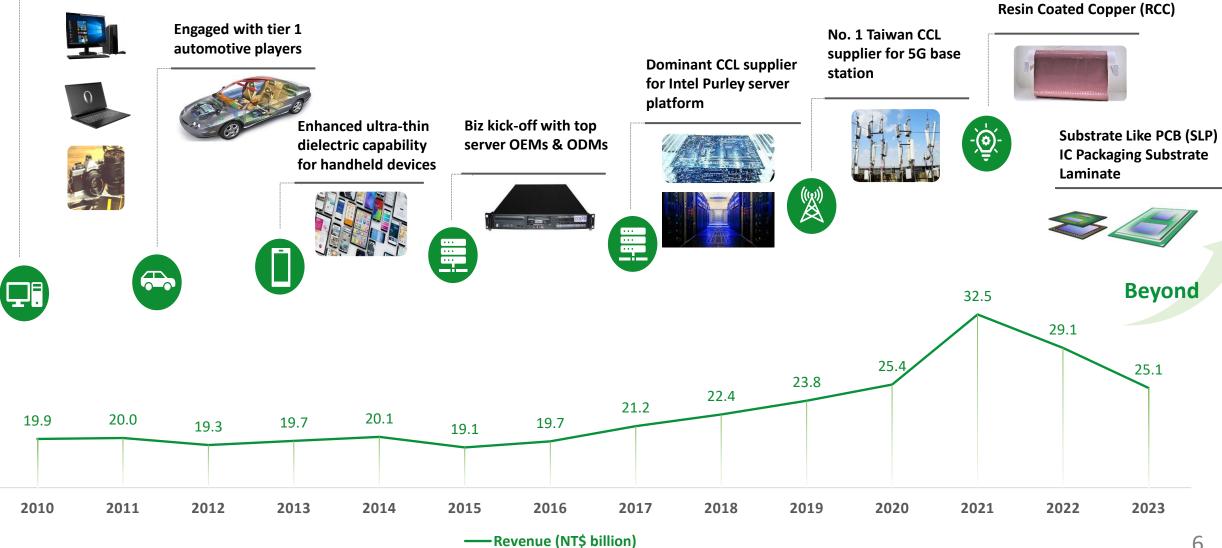


#### Path of Innovation

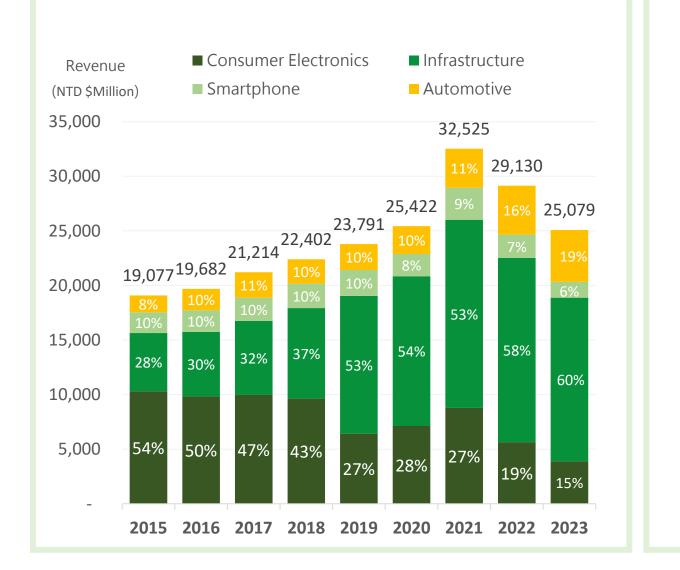
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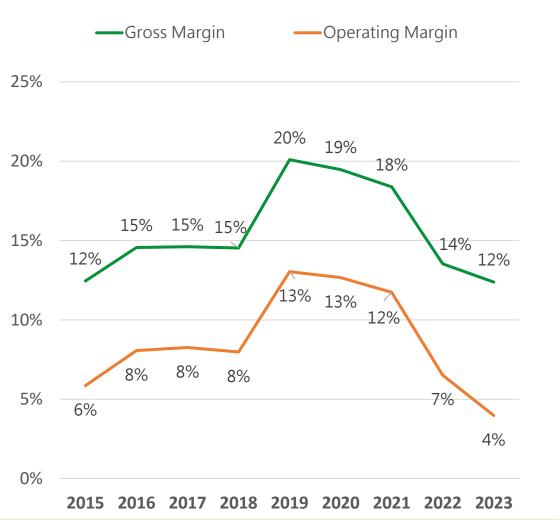
New product for HDI PCB:



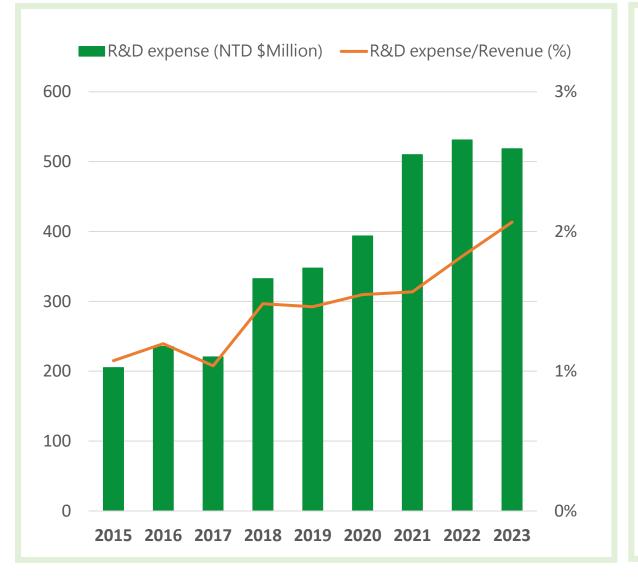


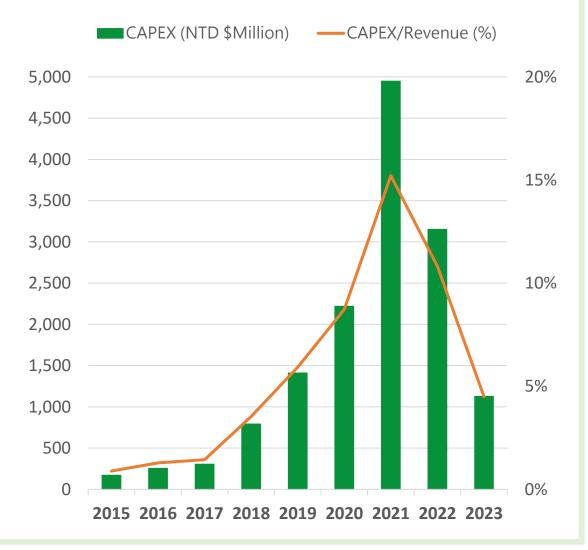
#### **Optimized Mix with Product Innovation**





#### R&D and Capex to Pursuit Sustainable Growth ITEQ



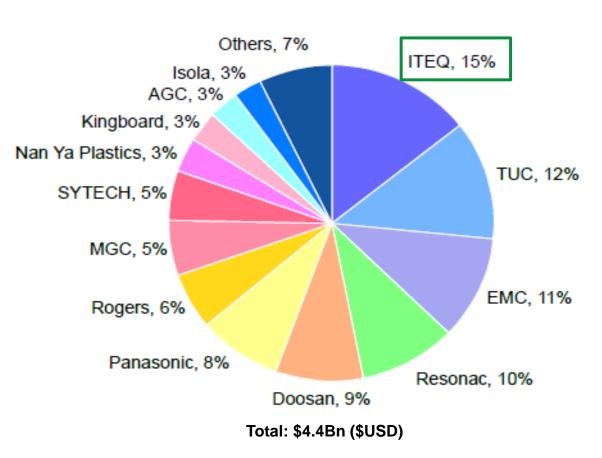


\*2023 CAPEX including the increase in prepayments for equipment NT\$560m. 8

### Market Share Leader in Specialty Laminate

#### 2022 WW Specialty Laminate Market Share

Revenue



\*Specialty Laminate includes: High speed, package substrate, RF Source: Prismark Report, 2023/06

 Worldwide top supplier in high speed / frequency laminate

**ITEQ: Leading CCL supplier** 

- Cutting-edge technology with MP track record
- Secular growth momentum in network infrastructure and data centers upgrading opportunities
- Rising EV market to boost demand for high speed / frequency automotive CCL



### Manufacturing Site & Capacity – Expansion PlaniteQ



(Phase I) - 2020 Laminate (600K SHT/Month) Prepreq (3,500K M/Month) (Phase II) - 2021 Laminate (600K SHT/Month) Prepreq (3,500K M/Month) (Phase III) - 2022 & 2023 Laminate (1,200K SHT/Month) Prepreg (5,000K M/Month)

WuXi Plant Laminate (1,650K SHT/Month) Prepreg (8,000K M/Month)

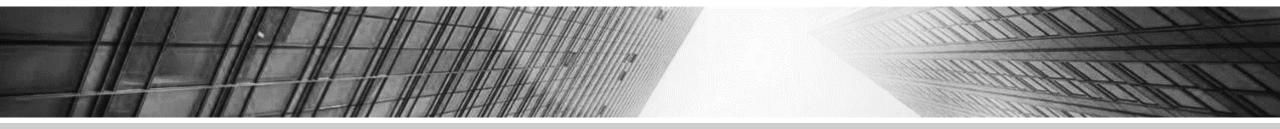
**DongGuan Plant** Laminate (1,000K SHT/Month) Prepreg (4,000K M/Month)

**GuangZhou Plant** FCCL (1,450 K M<sup>2</sup>/Month)

**HuangJiang Plant** Masslam Service (500K SQFT/Month)

HsinChu (Headquarters) Laminate (400K SHT/Month) Prepreg (2,400K M/Month)

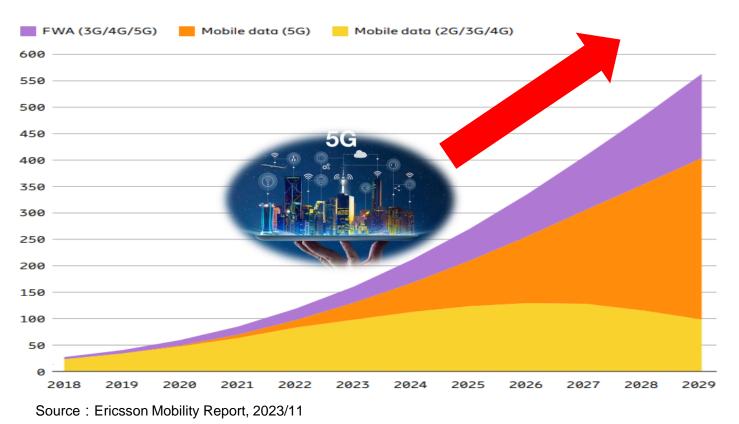
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## Market Trend & Growth Drivers ITEQ



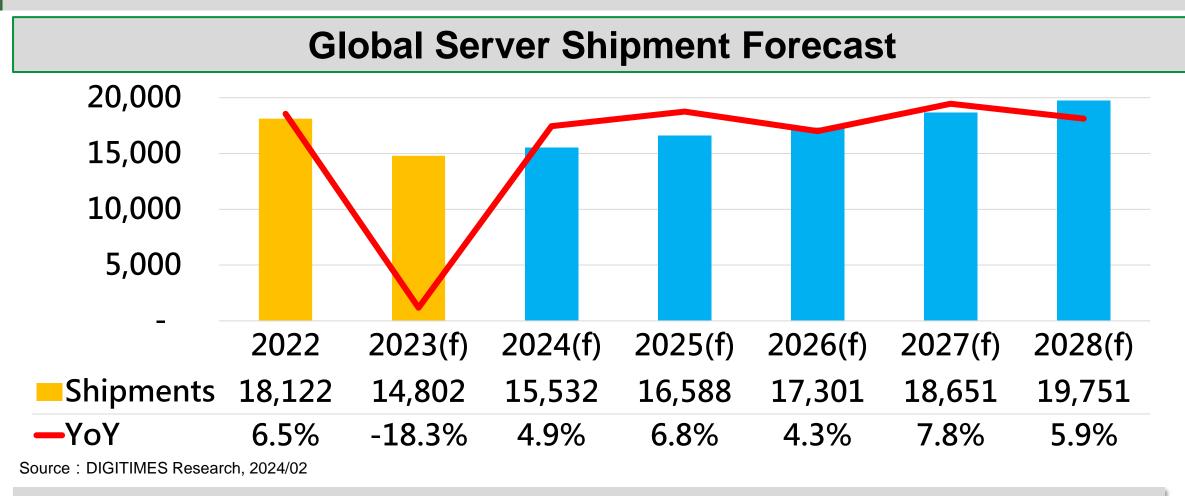
#### Hunger for High-Speed / Frequency Transmission ITEQ



#### Global Mobile Network Data Traffic (EB per month)

- The Expansion of Global Mobile Network Data Traffic Continues on the Rise
- Telecommunications equipment & datacenter
  - Base station, ground satellite transceiver station
  - Core (traditional / cloud datacenter)
  - Edge computing (Enterprise enhanced infrastructure, such as data center & internal/external servers, signal transmission stations, etc.)
- AI & High Performance Computing & Big Data Analysis
- Cloud Computing and Cloud Storage
- Internet of Vehicles (ADAS & Self-Driving)
- End user products (computers, smartphones, IoT devices)
- IoT related applications (Smart Home & Telemedicine)
- Virtual Reality (VR) and Augmented Reality (AR)
- The expansion of global mobile network data traffic has driven network service operators, telecommunications companies and IoT & IoV manufacturers to expand/upgrade product specs to meet the needs of Iow latency, high reliability and high-speed computing processing.

### Server Shipment Growth Intact from 2024



2023~2028 Global Server shipment CAGR forecast +6%;

- Generative AI to drive demand for both AI servers and general-purpose servers
- Al server robust demand to drive CCL content growth

#### **Datacenter Server Platform Upgrade**

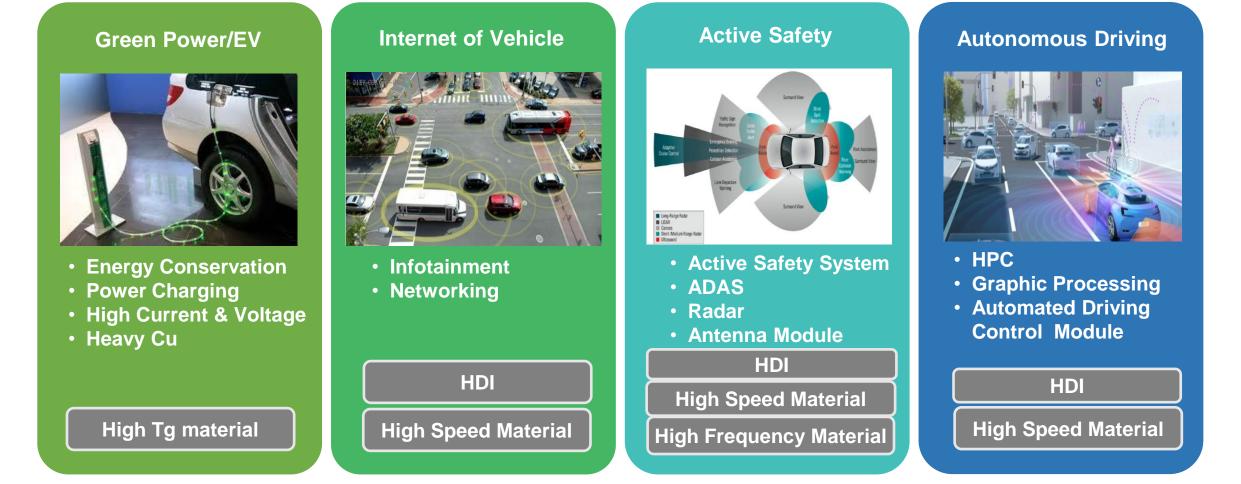
	Platform	Purley		Whitley	Eagle Stream		Birch Stream		
Intel	CPU	Skylake	Cascade Lake	Ice lake	Sapphire Rapids	Emerald Rapids	Granite Rapids		
	Nano Process	14 nm	14 nm+	10 nm	Intel 7	Intel 7	Intel 3	1至11至11	
	PCle Gen	PCle 3.0	PCle 3.0	PCle 4.0	PCle 5.0	PCle 5.0	PCle 5.0	調け対け	
	MP Time	2017 Q3	2019 Q3	2021 Q1	2023 H1	2023 H2	2024	(論) 割り	
	CCL Material	Mid Loss	Mid Loss	Low Loss	Very Low Loss	Very Low Loss	VLL/ Ultra Low Loss		
	Layer count	8 to 12	8 to 12	12 to 16	16 to 20	16 to 20	18 to 22		
									eRacks
	Architecture	Zen	Zen2	Zen3	Zen4		Zen5		
	CPU	Naples	Rome	Milan	Genoa	Bergamo	Turin		
AMD	Nano Process	<b>14 nm</b> (Global Foundries)	7 nm (TSMC)	7 nm (TSMC)	5 nm (TSMC)	5 nm (TSMC)	4 nm / 3 nm (TSMC)		
	PCle Gen	PCle 3.0	PCIe 4.0	PCIe 4.0	PCle 5.0	PCle 5.0	PCle 5.0		0
	MP Time	2017 Q3	2019 Q3	2020 Q4	2022 Q4	2023	2024		
	CCL Material	Mid Loss	Low Loss	Low Loss	Very Low Loss	Very Low Loss	VLL/ Ultra Low Loss		20 Oueleios 10 June 10 10 June 10 0 Dueleios
	Layer count	8 to 12	12 to 16	12 to 16	16 to 20	16 to 20	18 to 22	A set a s	DualBIOS

Datacenter Equipment Cyclical Upgrade to Drive the Following;

- Corresponding CCL material upgrade
- Increase consumption and layer counts for CCL



### **Advanced Auto Application Opportunities**

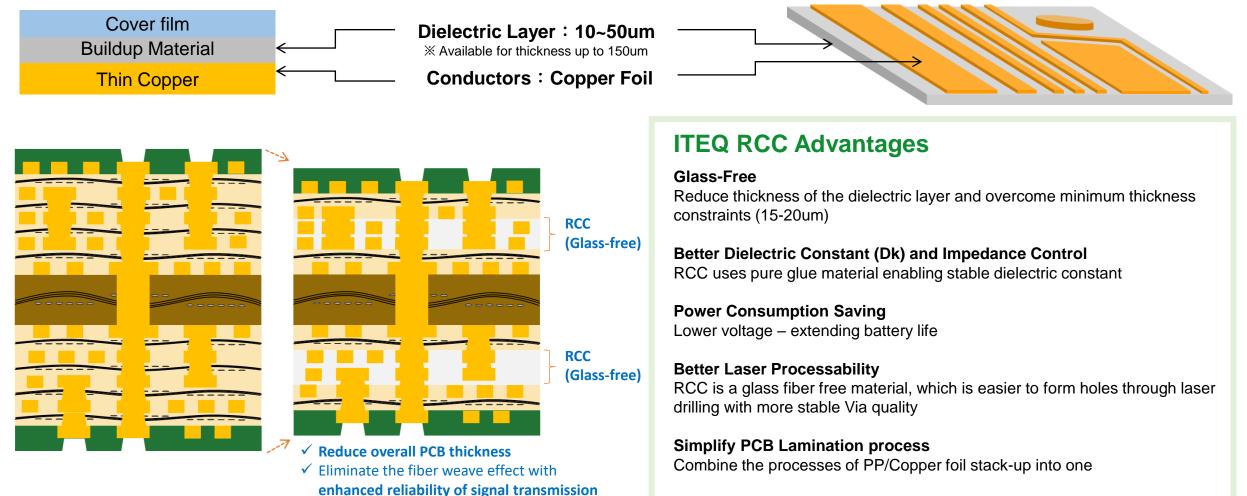


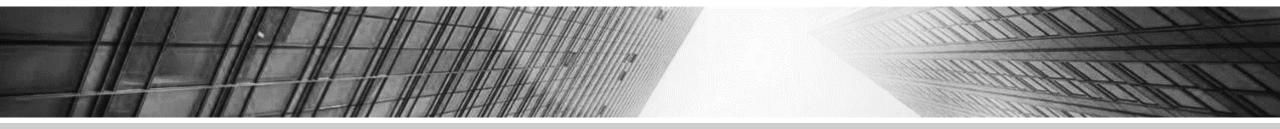
- EV, IoV and Active Safety to boost demand for high performance automotive CCL
- PCB usage for EV is 4 to 5 folds of conventional gasoline vehicle

### HDI New Product: Resin Coated Copper (RCC) ITEQ

#### **Resin Coated Copper (RCC)**

✓ Glass-free solution which enables further thickness reduction of dielectric layer while satisfies the needs towards fine-line pattern design (smaller form factor) and hybrid HDI/Substrate-Like PCB production.





## 4Q23 & 2023 Financial Results ITEQ



#### 4Q23 & FY23 Income Statement

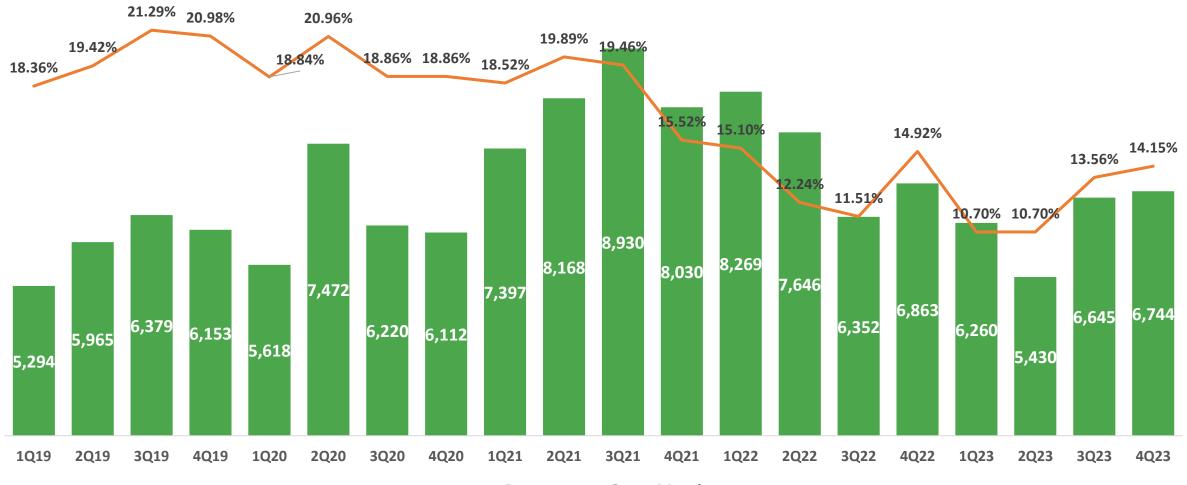


NTD \$Million	4Q23	3Q23	4Q22	QoQ	YoY	2023	2022	YoY
Revenue	6,744	6,645	6,863	1.5%	-1.7%	25,079	29,130	-13.9%
Gross Profit	954	901	1,024	5.9%	-6.8%	3,106	3,940	-21.2%
Operating Expense	535	511	570	4.7%	-6.1%	2,111	2,043	3.3%
<b>Operating Profit</b>	419	390	454	7.4%	-7.7%	995	1,896	-47.5%
Non-Op Income / Loss	132	(4)	(72)			157	419	
Income before Tax	551	386	381	42.7%	44.6%	1,152	2,315	-50.2%
Tax Expense	225	151	47			476	460	
Net Income to Parent	326	235	334	38.7%	-2.4%	677	1,855	-63.5%
EPS(NT\$)	0.90	0.65	0.92	38.5%	-2.2%	1.86	4.94	-62.3%
Key Financial Ratio								
Gross Margin	14.15%	13.56%	14.92%			12.38%	13.52%	
Operating Expense Ratio	7.93%	7.69%	8.31%			8.42%	7.01%	
<b>Operating Margin</b>	6.21%	5.87%	6.60%			3.97%	6.51%	
Effective Tax Rate	40.83%	39.12%	12.34%			41.32%	19.87%	
Net Margin	4.83%	3.54%	4.87%			2.70%	6.37%	

#### **Revenue & Gross Margin Rate**

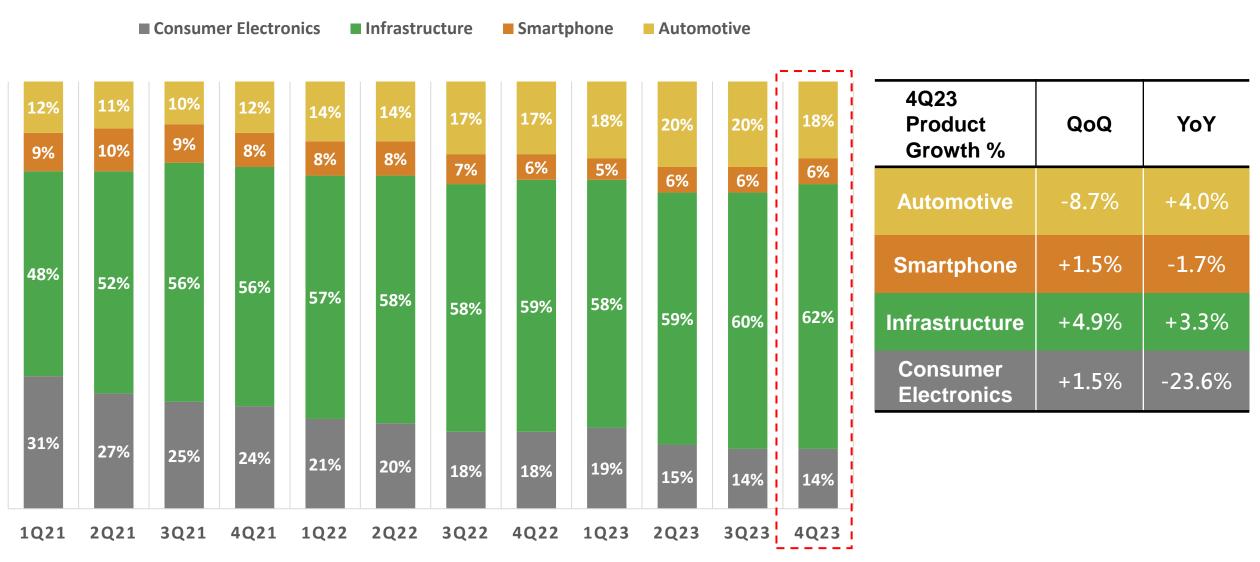


(Million \$NTD)



Revenue — Gross Margin

#### **Product Mix**



#### 4Q23 Balance Sheet

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NTD \$Million	4Q23	3Q23	4Q22
Total Assets	33,380	33,881	33,383
Cash	5,594	6,030	5,214
NR / AR	11,498	11,470	12,119
Inventories	3,014	2,834	2,731
Fixed Assets	11,180	11,387	11,102
Total Liabilities	13,940	14,126	13,272
Short-term Debt	2,921	2,554	2,633
NP / AP	5,991	6,332	5,926
Long-term Debt	2,346	2,600	1,677
Total Equity	19,440	19,755	20,111
Key Financial Index			
Days Sales Outstanding	172	171	159
Days Sales of Inventory	54	52	62
Days Payable Outstanding	99	102	95
ROE (%)	3.42	3.43	8.96
ROA (%)	2.37	2.33	5.57
Debt ratio (%)	41.76	41.69	39.76

#### 2017 – 2023 Dividend Policy



Year	EPS(NT\$)	Dividend(NT\$)	Cash Dividend(NT\$)	Pay-out Ratio(%)
2017	4.11	3.1	3.1	75%
2018	5.86	3.8	3.8	65%
2019	8.13	5.0	5.0	62%
2020	8.19	5.0	5.0	61%
2021	9.00	5.0	5.0	56%
2022	4.94	3.0	3.0	61%
2023	1.86	1.5	1.5	81%

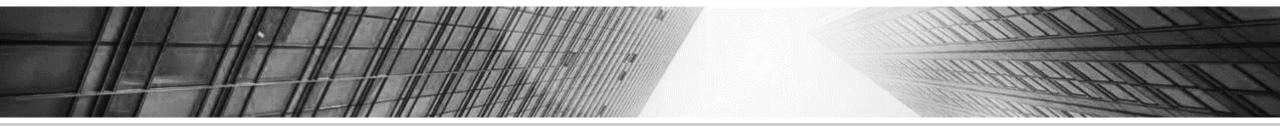
\*New shares issuance of 30 million common shares concluded on March 31<sup>st</sup> 2020

\*\*New shares issuance of 50 million common shares concluded on September 2<sup>nd</sup> 2021

\*\*\*Factoring in the repurchase and cancellation of 20 million shares in 3Q22; current total outstanding common share: 363 million

# Thank you

**Question and Comment** 



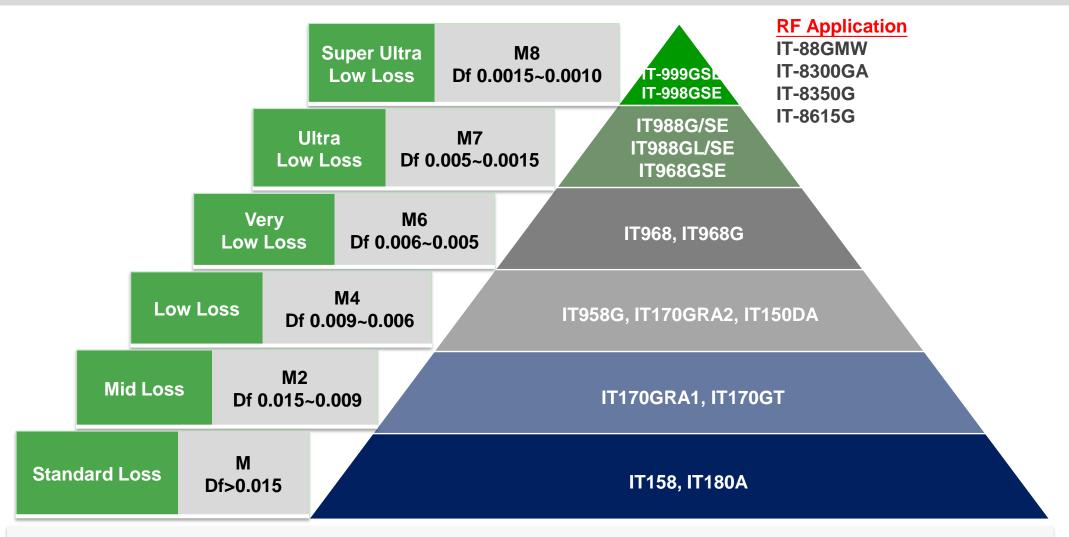
## Appendix





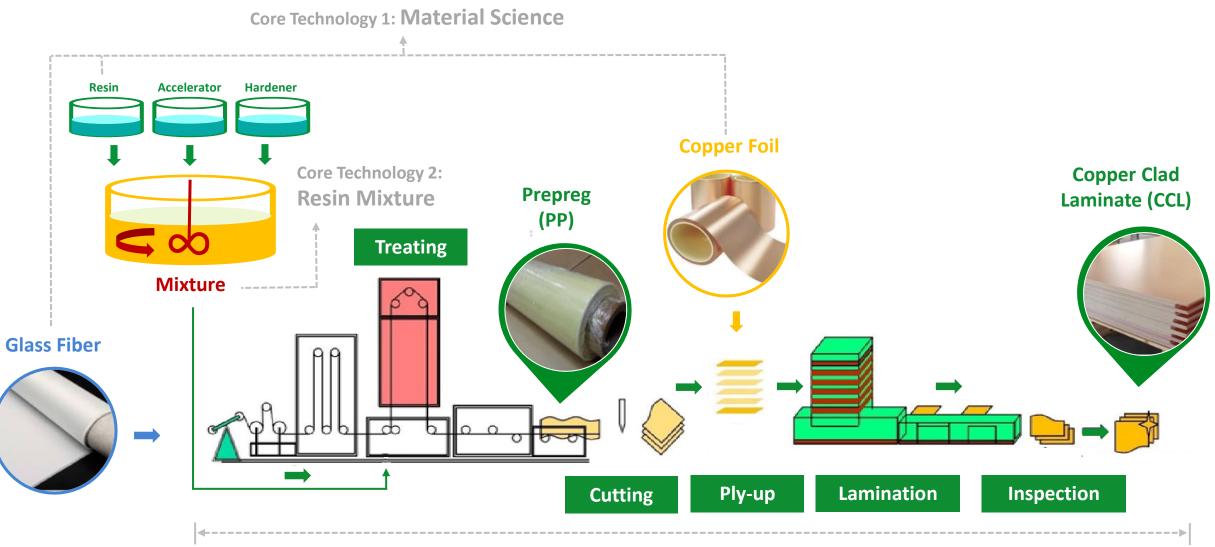
#### **Well-Expanded Product Line**





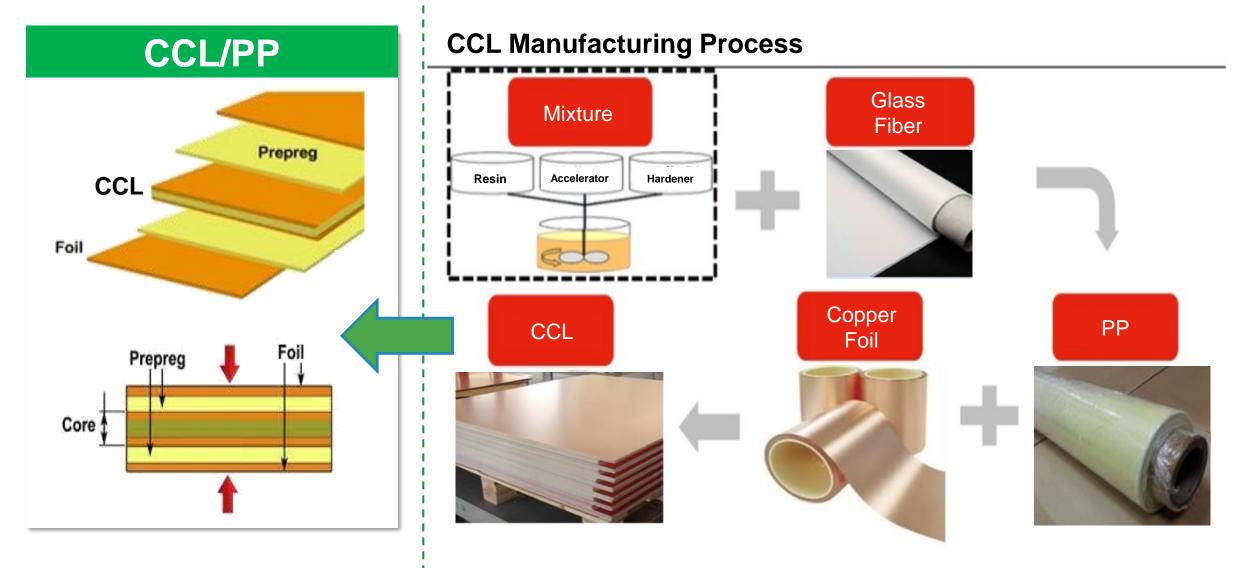
- The need for hyperscale data center and server upgrade to expedite the growth of high speed / frequency material demand
- ITEQ's market share in high speed / frequency material to uplift robustly

### **CCL & PP Manufacturing Flow**



Core Technology 3: Process Engineering

#### **CCL & PP Composite Structure**





#### Al Server Robust Demand to Drive CCL Content Growth ITEQ

